## AMENDMENTS TO THE CLAIMS

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2. (currently amended) The integrated cooling device of claim 1 wherein said
liquid coolant-is-circulated-through a-tubing arrangementAn integrated cooling device
comprising:
a reservoir configured to contain a liquid coolant circulated through a
Jubing arrangement:
a pump disposed within said reservoir, said pump being configured to
circulate said liquid coolant between said reservoir and a heat source;
a fan configured to provide a flow of air across said circulating liquid
coolant; and
a motor disposed within said reservoir, said motor being operably
connected to said pump and said fan.
<ul><li>3. (cancelled)</li><li>4. (previously presented) A cooling unit configured to circulate a liquid coolan</li></ul>
said cooling unit comprising:
a reservoir configured to contain said liquid coolant;
a tubing arrangement disposed at an outer surface of said reservoir, said
tubing arrangement being fluidly communicable with a heat exchanging device;
a pump disposed within said reservoir, said pump being configured to
circulate said liquid coolant through said tubing arrangement to said heat exchanging
device;
a fan configured to provide a flow of air across said tubing arrangement;
and
a motor disposed within said reservoir, said motor being operably

connected to said pump and said fan.

- 5. (cancelled)
- 6. (original) The cooling unit of claim 4 wherein said tubing arrangement is coiled over said outer surface of said reservoir.
- 7. (original) The cooling unit of claim 4 wherein said fan is configured to provide a forced induction of air over said tubing arrangement.
- 8. (original) The cooling unit of claim 4 further comprising a plurality of fins disposed over said tubing arrangement, said fins extending longitudinally in a direction of said flow of air across said tubing arrangement.
- 9. (original) The cooling unit of claim 8 wherein said fins are tubular in structure.
- 10. (original) The cooling unit of claim 9 wherein said tubularly structured fins are open at the ends thereof, thereby allowing said flow of air to be maintained within said fins.
- 11. (original) The cooling unit of claim 8 wherein said fins are fabricated from copper, copper alloys, aluminum, aluminum alloys, and combinations of the foregoing materials.
- 12. (original) he cooling unit of claim 8 further comprising a shroud disposed over said fins.
  - 13. (original) The cooling unit of claim 12 wherein said shroud defines a

primary air inlet at a lower end thereof.

- 14. (original) The cooling unit of claim 12 wherein said shroud includes a secondary air inlet disposed therein, said secondary air inlet being configured to allow for airflow communication between opposing sides of said shroud.
- 15. (original) The cooling unit of claim 14 wherein said secondary air inlet is positioned on said shroud to register with a space defined by adjacently positioned fins.
- 16. (original) The cooling unit of claim 14 wherein said secondary air inlet includes an air directing tab associated therewith, said air directing tab being configured to channel air into said secondary air inlet upon a forced induction of air by said fan.
- 17. (original) The cooling unit of claim 12 wherein said shroud is fabricated from a material selected from the group consisting of plastic, metal, fiberglass, and combinations of the foregoing materials.
- 18. (original) The cooling unit of claim 4 further comprising a cover disposed over said fan.
  - 19. (original) The cooling unit of claim 18 wherein said cover comprises, a frame, and a plurality of vanes pivotally mounted within said frame, said vanes being
- configured to rotate into an open position in response to an airflow generated by said fan
- 20. (previously presented) A thermal dissipation system, comprising: a heat exchanging unit; and a cooling unit disposed in fluid communication with said heat exchanging unit, said cooling unit comprising,

- a reservoir configured to contain a liquid coolant,
  a pump disposed within said reservoir, said pump being configured to
  circulate a liquid coolant between said reservoir and said heat exchanging unit;
  a fan configured to remove heat from said liquid coolant; and
  a motor disposed within said reservoir.
- 21. (original) The thermal dissipation system of claim 20 wherein said heat exchanging unit is a cold plate.
- 22. (original) The thermal dissipation system of claim 21 wherein said cold plate is disposed in communication with electronic circuitry.
- 23. (previously presented) The thermal dissipation system of claim 20 wherein said motor is disposed in operable communication with said pump and said fan.